N-Channel 150-V (D-S) 175°C MOSFET

CHARACTERISTICS

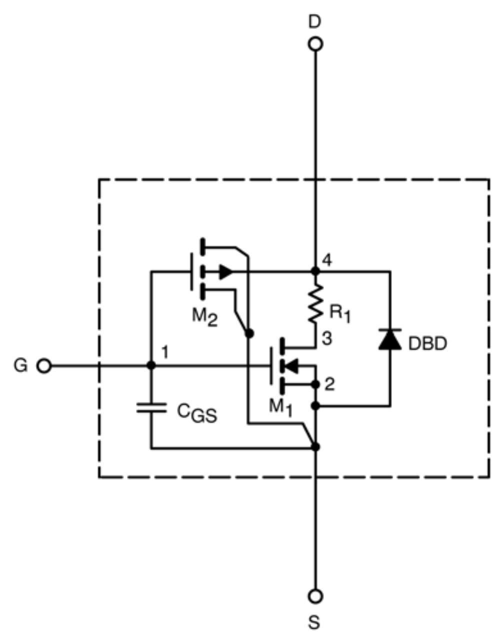
- N-Channel Vertical DMOS
- Macro Model (Subcircuit Model)
- Level 3 MOS
- Apply for both Linear and Switching Application
- Accurate over the −55 to 125°C Temperature Range
- Model the Gate Charge, Transient, and Diode Reverse Recovery Characteristics

DESCRIPTION

The attached spice model describes the typical electrical characteristics of the n-channel vertical DMOS. The subcircuit model is extracted and optimized over the −55 to 125°C temperature ranges under the pulsed 0-V to 10-V gate drive. The saturated output impedance is best fit at the gate bias near the threshold voltage.

A novel gate-to-drain feedback capacitance network is used to model the gate charge characteristics while avoiding convergence difficulties of the switched C_{gd} model. All model parameter values are optimized to provide a best fit to the measured electrical data and are not intended as an exact physical interpretation of the device.

SUBCIRCUIT MODEL SCHEMATIC

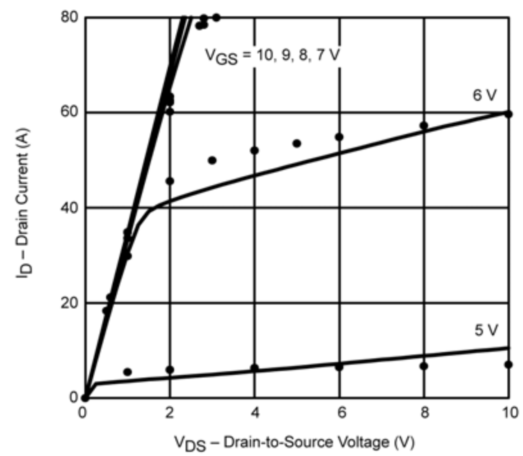


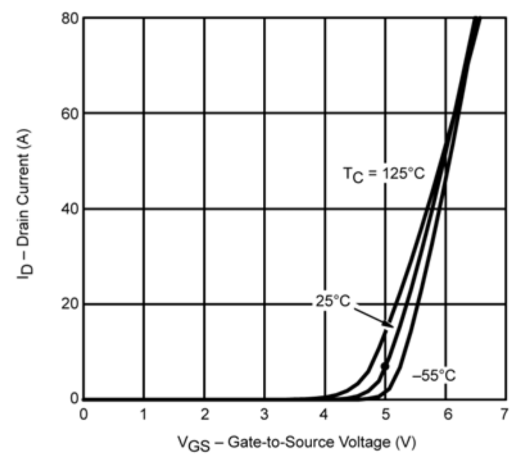
This document is intended as a SPICE modeling guideline and does not constitute a commercial product data sheet. Designers should refer to the appropriate data sheet of the same number for guaranteed specification limits.

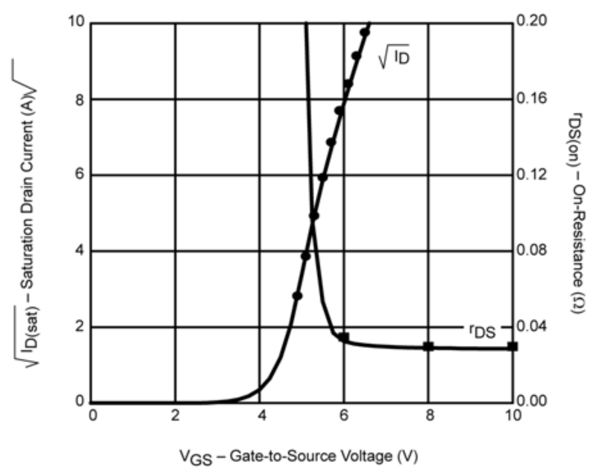
SPECIFICATIONS (T_J = 25°C UNLESS OTHERWISE NOTED)					
Parameter	**Symbol**	**Test Condition**	**Simulated Data**	**Measured Data**	**Unit**
Static					
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$, I_D = 250 µA	3		V
On-State Drain Current[a]	$I_{D(on)}$	V_{DS} = 5 V, V_{GS} = 10 V	172		A
Drain-Source On-State Resistance[a]	$r_{DS(on)}$	V_{GS} = 10 V, I_D = 15 A	0.029	0.030	Ω
		V_{GS} = 10 V, I_D = 15 A, T_J = 125°C	0.050		
		V_{GS} = 10 V, I_D = 15 A, T_J = 175°C	0.061		
		V_{GS} = 6 V, I_D = 10 A	0.031	0.033	
Forward Voltage[a]	V_{SD}	I_F = 40 A, V_{GS} = 0 V	0.90	1	V
Dynamic[b]					
Input Capacitance	C_{iss}	V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz	2344	2500	pF
Output Capacitance	C_{oss}		340	290	
Reverse Transfer Capacitance	C_{rss}		221	190	
Total Gate Charge[c]	Q_g	V_{DS} = 75 V, V_{GS} = 10 V, I_D = 40 A	44	38	nC
Gate-Source Charge[c]	Q_{gs}		13	13	
Gate-Drain Charge[c]	Q_{gd}		13	13	
Turn-On Delay Time[c]	$t_{d(on)}$	V_{DD} = 75 V, R_L = 1.8 Ω $I_D \cong$ 40 A, V_{GEN} = 10 V, R_G = 2.5 Ω	30	15	ns
Rise Time[c]	t_r		15	130	
Turn-Off Delay Time[c]	$t_{d(off)}$		33	30	
Fall Time[c]	t_f		15	90	

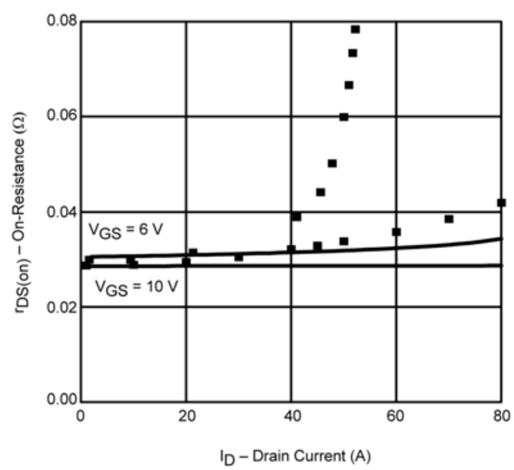
Notes
a. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2%.
b. Guaranteed by design, not subject to production testing.
c. Independent of operating temperature.

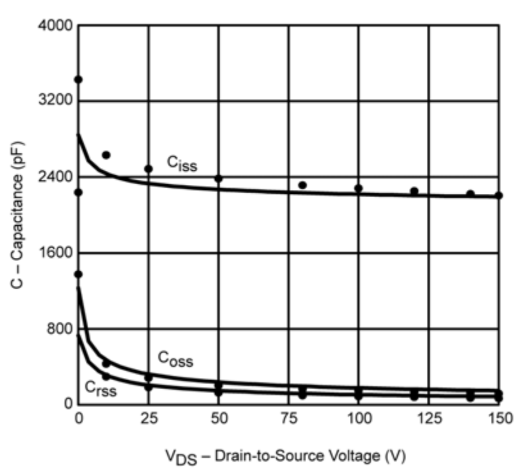
COMPARISON OF MODEL WITH MEASURED DATA (T_J=25°C UNLESS OTHERWISE NOTED)

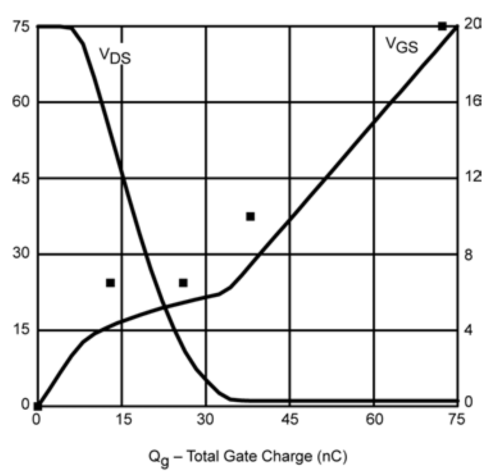












Note: Dots and squares represent measured data.

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